



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Tan et al.

Serial No.: 10/642,908

Filed: August 18, 2003

For: SOLDER MASKS FOR USE ON
CARRIER SUBSTRATES, CARRIER
SUBSTRATES AND SEMICONDUCTOR
DEVICE ASSEMBLIES INCLUDING
SUCH SOLDER MASKS, AND METHODS

Examiner: Unknown

Group Art Unit: 3712

Attorney Docket No.: 2269-5163.1US
(01-0910.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

December 18, 2003
Date

Signature

Deidra Pfeil
Name (Type/Print)

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Attached is a copy of the official filing receipt received from the PTO in the above application. Issuance of a corrected filing receipt in accordance with the annotations on the attached filing receipt copy is respectfully requested.

The errors to be corrected are as follows:

In the Applicant Section:

Please change "Cheng Pour Poh" to --Cheng Poh Pour--.

Serial No.: 10/642,908

These corrections are not due to any errors by Applicants and no fee is due.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Brick G. Power". The signature is fluid and cursive, with the first name "Brick" being more prominent.

Brick G. Power

Registration No. 38,581

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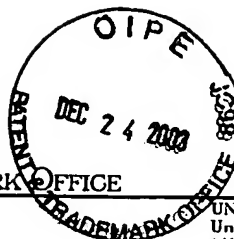
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Enclosure: Copy of Official Filing Receipt with annotations correcting errors

Document in ProLaw



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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/642,908	08/18/2003	3712	1080	2269-5163.1US (01-0910.01	4	29	5

24247
 TRASK BRITT
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 SALT LAKE CITY, UT 84110

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CONFIRMATION NO. 3189

FILING RECEIPT



OC000000011377990

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Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Cheng Poh Poh

Domestic Priority data as claimed by applicant

This application is a DIV of 10/120,169 04/10/2002

Foreign Applications

If Required, Foreign Filing License Granted: 11/28/2003

Projected Publication Date: 03/11/2004

Non-Publication Request: No

Early Publication Request: No

Title

Solder masks for use on carrier substrates, carrier substrates and semiconductor device assemblies including such solder masks, and methods

Preliminary Class

446

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Title 37, Code of Federal Regulations, 5.11 & 5.15**

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